DISCRETE SEMICONDUCTORS

DATA SHEET



BB145B Low-voltage variable capacitance diode

Product specification Supersedes data of 2002 Nov 18 2004 Mar 29





Low-voltage variable capacitance diode

BB145B

FEATURES

• Ultra small plastic SMD package

• C4: 2.75 pF; ratio: 2.4

• Low series resistance.

APPLICATIONS

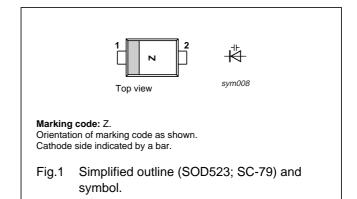
• Voltage controlled oscillators (VCO).

DESCRIPTION

The BB145B is a planar technology variable capacitance diode in a SOD523 (SC-79) package.

PINNING

PIN	DESCRIPTION	
1	cathode	
2	anode	



ORDERING INFORMATION

TYPE		PACKAGE		
NUMBER	NAME	DESCRIPTION	VERSION	
BB145B	_	plastic surface mounted package; 2 leads	SOD523	

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _R	continuous reverse voltage		_	6	V
V_{RM}	peak reverse voltage	in series with a 10 kΩ resistor	_	8	V
I _F	continuous forward current		_	20	mA
T _{stg}	storage temperature		- 55	+150	°C
Tj	operating junction temperature		-55	+150	°C

ELECTRICAL CHARACTERISTICS

 $T_i = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _R	reverse current	V _R = 6 V; see Fig.3	_	10	nA
		V _R = 6 V; T _j = 85 °C; see Fig.3	_	200	nA
r _s	diode series resistance	f = 470 MHz; V _R = 1 V	_	0.6	Ω
C _d	diode capacitance	$V_R = 1 \text{ V}$; f = 1 MHz; see Figs 2 and 4	6.4	7.2	pF
		$V_R = 4 \text{ V}$; f = 1 MHz; see Figs 2 and 4	2.55	2.95	pF
C _{d(1V)}	capacitance ratio	f = 1 MHz	2.2	_	
$\frac{C_{d(1V)}}{C_{d(4V)}}$					

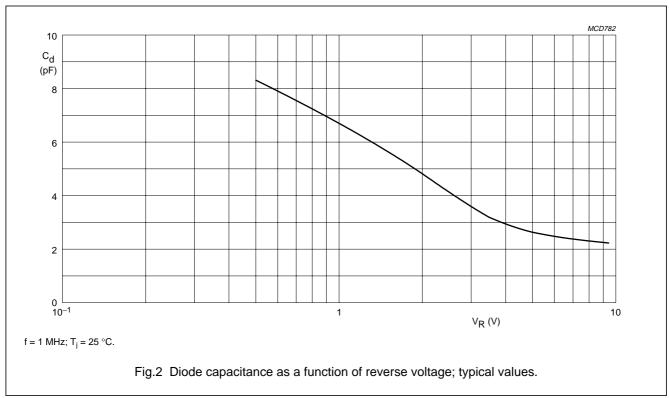
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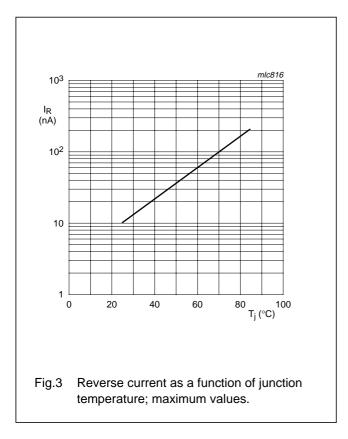
Philips Semiconductors Product specification

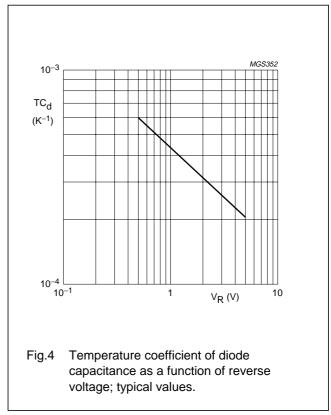
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GRAPHICAL DATA







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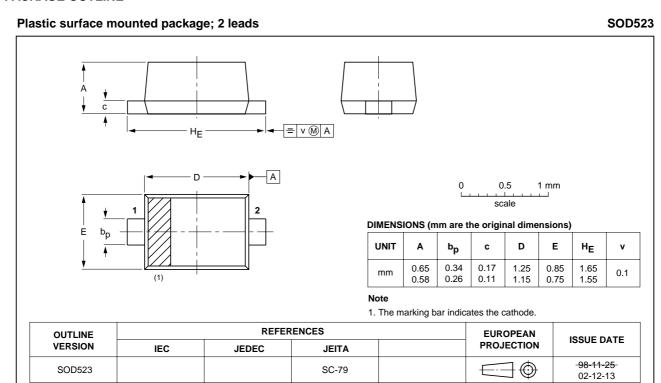
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BB145B

PACKAGE OUTLINE

SOD523



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Low-voltage variable capacitance diode

BB145B

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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